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December 2013



## 74LCX00 Low Voltage Quad 2-Input NAND Gate with 5V Tolerant Inputs

## Features

- 5V tolerant inputs
- 2.3V–3.6V V<sub>CC</sub> specifications provided
- 5.2ns t<sub>PD</sub> max. (V<sub>CC</sub> = 3.3V), 10µA I<sub>CC</sub> max.
- Power down high impedance inputs and outputs
- ±24mA output drive (V<sub>CC</sub> = 3.0V)
- Implements proprietary noise/EMI reduction circuitry
- Latch-up performance exceeds JEDEC 78 conditions
- ESD performance:
- Human body model > 2000V
- Machine model > 200V
- Leadless DQFN package

## General Description

The LCX00 contains four 2-input NAND gates. The inputs tolerate voltages up to 7V allowing the interface of 5V systems to 3V systems.

The 74LCX00 is fabricated with advanced CMOS technology to achieve high speed operation while maintaining CMOS low power dissipation.

| Ordering Infor            | mation            |   |  |  |  |  |
|---------------------------|-------------------|---|--|--|--|--|
| Order Number              | Package<br>Number | Package Description   |  |  |  |  |
| 74LCX00M                  | M14A              | 4-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow                 |  |  |  |  |
| 74LCX00SJ                 | M14D              | 4-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide                                |  |  |  |  |
| 74LCX00BQX <sup>(1)</sup> | MLP14A            | 14-Terminal Depopulated Quad Very-Thin Flat Pack No Leads (DQFN), JEDEC MO-241, 2.5 x 3.0mm |  |  |  |  |
| 74LCX00MTC                | MTC14             | 14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide                 |  |  |  |  |

#### Note:

1. DQFN package available in Tape and Reel only.

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering number.

All packages are lead free per JEDEC: J-STD-020B standard.

74LCX00 — Low Voltage Quad 2-Input NAND Gate with 5V Tolerant Inputs

#### **Connection Diagrams** Pin Assignments for SOIC, SOP, and TSSOP 14 A<sub>0</sub> V<sub>CC</sub> 13 B<sub>0</sub> Α2 12 $\overline{O}_0$ B2 11 $\overline{0}_2$ A<sub>1</sub> 10 В<sub>1</sub> $A_3$ 9 $\overline{0}_1$ Bγ 8 GND 03 Pad Assignments for DQFN A<sub>0</sub> V<sub>CC</sub> 14 1 1 14 13 (13 A<sub>2</sub> B<sub>0</sub>2 $\overline{O}_0$ (12 B<sub>2</sub> D A<sub>1</sub> $(11\overline{O}_2$ 4 A В<sub>1</sub> 5 (10 A3 P 9 B3 9 6

Logic Symbol IEEE/IEC A<sub>0</sub> & B<sub>0</sub> & A<sub>1</sub> & B<sub>1</sub> & A<sub>2</sub> & B<sub>2</sub> & A<sub>3</sub> &

 $B_3$ 

 $\overline{0}_0$ 

0,

- 0<sub>2</sub>

 $\overline{0}_3$ 

## **Pin Description**

| Pin Names                       | Description |
|---------------------------------|-------------|
| A <sub>n</sub> , B <sub>n</sub> | Inputs      |
| Ōn                              | Outputs     |
| DAP                             | No Connect  |

7 8 GND 03

(Top View)

8 7

(Bottom View)

Note: DAP (Die Attach Pad)

## **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

| Symbol           | Parameter   | Rating                          |
|------------------|---|---------------------------------|
| V <sub>CC</sub>  | Supply Voltage  | -0.5V to +7.0V                  |
| VI               | DC Input Voltage  | -0.5V to +7.0V                  |
| Vo               | DC Output Voltage, Output in HIGH or LOW State <sup>(2)</sup> | -0.5V to V <sub>CC</sub> + 0.5V |
| I <sub>IK</sub>  | DC Input Diode Current, V <sub>I</sub> < GND                  | –50mA                           |
| I <sub>ОК</sub>  | DC Output Diode Current                                       |                                 |
|                  | V <sub>O</sub> < GND  | –50mA                           |
|                  | V <sub>O</sub> > V <sub>CC</sub>                              | +50mA                           |
| Ι <sub>Ο</sub>   | DC Output Source/Sink Current                                 | ±50mA                           |
| I <sub>CC</sub>  | DC Supply Current per Supply Pin                              | ±100mA                          |
| I <sub>GND</sub> | DC Ground Current per Ground Pin                              | ±100mA                          |
| T <sub>STG</sub> | Storage Temperature   | –65°C to +150°C                 |

#### Note:

2. I<sub>O</sub> Absolute Maximum Rating must be observed.

## Recommended Operating Conditions<sup>(3)</sup>

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

| Symbol                            | Parameter   | Min. | Max.            | Units |
|-----------------------------------|---|------|-----------------|-------|
| V <sub>CC</sub>                   | Supply Voltage  |      |                 |       |
|                                   | Operating   | 2.0  | 3.6             | V     |
|                                   | Data Retention  | 1.5  | 3.6             |       |
| VI                                | Input Voltage   | 0    | 5.5             | V     |
| Vo                                | Output Voltage, HIGH or LOW State                       | 0    | V <sub>CC</sub> | V     |
| I <sub>OH</sub> / I <sub>OL</sub> | Output Current  |      |                 |       |
|                                   | $V_{CC} = 3.0V - 3.6V$                                  |      | ±24             | mA    |
|                                   | $V_{CC} = 2.7V - 3.0V$                                  |      | ±12             |       |
|                                   | $V_{CC} = 2.3V - 2.7V$                                  |      | ±8              |       |
| T <sub>A</sub>                    | Free-Air Operating Temperature                          | -40  | 85              | °C    |
| $\Delta t / \Delta V$             | Input Edge Rate, $V_{IN} = 0.8V-2.0V$ , $V_{CC} = 3.0V$ | 0    | 10              | ns/V  |

#### Note:

3. Unused inputs must be held HIGH or LOW. They may not float.

#### **DC Electrical Characteristics**

|                  |                                       |                     |                                    | T <sub>A</sub> = -40°C | to +85°C |       |
|------------------|---------------------------------------|---------------------|------------------------------------|------------------------|----------|-------|
| Symbol           | Parameter                             | V <sub>CC</sub> (V) | Conditions                         | Min.                   | Max.     | Units |
| V <sub>IH</sub>  | HIGH Level Input Voltage              | 2.3–2.7             |                                    | 1.7                    |          | V     |
|                  |                                       | 2.7–3.6             |                                    | 2.0                    |          |       |
| V <sub>IL</sub>  | LOW Level Input Voltage               | 2.3–2.7             |                                    |                        | 0.7      | V     |
|                  |                                       | 2.7–3.6             |                                    |                        | 0.8      |       |
| V <sub>OH</sub>  | HIGH Level Output Voltage             | 2.3–3.6             | $I_{OH} = -100 \mu A$              | V <sub>CC</sub> - 0.2  |          | V     |
|                  |                                       | 2.3                 | $I_{OH} = -8mA$                    | 1.8                    |          |       |
|                  |                                       | 2.7                 | $I_{OH} = -12mA$                   | 2.2                    |          |       |
|                  |                                       | 3.0                 | $I_{OH} = -18 \text{mA}$           | 2.4                    |          |       |
|                  |                                       |                     | $I_{OH} = -24mA$                   | 2.2                    |          |       |
| V <sub>OL</sub>  | LOW Level Output Voltage              | 2.3–3.6             | I <sub>OL</sub> = 100μA            |                        | 0.2      | V     |
|                  |                                       | 2.3                 | $I_{OL} = 8 mA$                    |                        | 0.6      |       |
|                  |                                       | 2.7                 | $I_{OL} = 12mA$                    |                        | 0.4      |       |
|                  |                                       | 3.0                 | I <sub>OL</sub> = 16mA             |                        | 0.4      |       |
|                  |                                       |                     | $I_{OL} = 24mA$                    |                        | 0.55     |       |
| l <sub>l</sub>   | Input Leakage Current                 | 2.3–3.6             | $0 \le V_I \le 5.5V$               |                        | ±5.0     | μA    |
| I <sub>OFF</sub> | Power-Off Leakage Current             | 0                   | $V_{\rm I}$ or $V_{\rm O} = 5.5 V$ |                        | 10       | μA    |
| I <sub>CC</sub>  | Quiescent Supply Current              | 2.3–3.6             | $V_I = V_{CC}$ or GND              |                        | 10       | μA    |
|                  |                                       |                     | $3.6V \le V_I \le 5.5V$            |                        | ±10      |       |
| $\Delta I_{CC}$  | Increase in I <sub>CC</sub> per Input | 2.3–3.6             | $V_{IH} = V_{CC} - 0.6V$           |                        | 500      | μA    |

## **AC Electrical Characteristics**

|                                       | $T_{A} = -40^{\circ}C \text{ to } +85^{\circ}C, R_{L} = 500\Omega$ |   |      |  |      |   |      |       |
|---------------------------------------|--|---|------|--|------|---|------|-------|
|                                       |  | $\begin{array}{l} V_{CC}=3.3V\pm0.3V,\\ C_{L}=50pF \end{array}$ |      | V <sub>CC</sub> = 2.7V,<br>C <sub>L</sub> = 50pF |      | $V_{CC} = 2.5V \pm 0.2V,$<br>$C_L = 30 \text{pF}$ |      |       |
| Symbol                                | Parameter  | Min.  | Max. | Min.   | Max. | Min.  | Max. | Units |
| t <sub>PHL</sub> , t <sub>PLH</sub>   | Propagation Delay  | 1.5   | 5.2  | 1.5  | 6.0  | 1.5   | 6.2  | ns    |
| t <sub>OSHL</sub> , t <sub>OSLH</sub> | Output to Output Skew <sup>(4)</sup>                               |   | 1.0  |  |      |   |      | ns    |

#### Note:

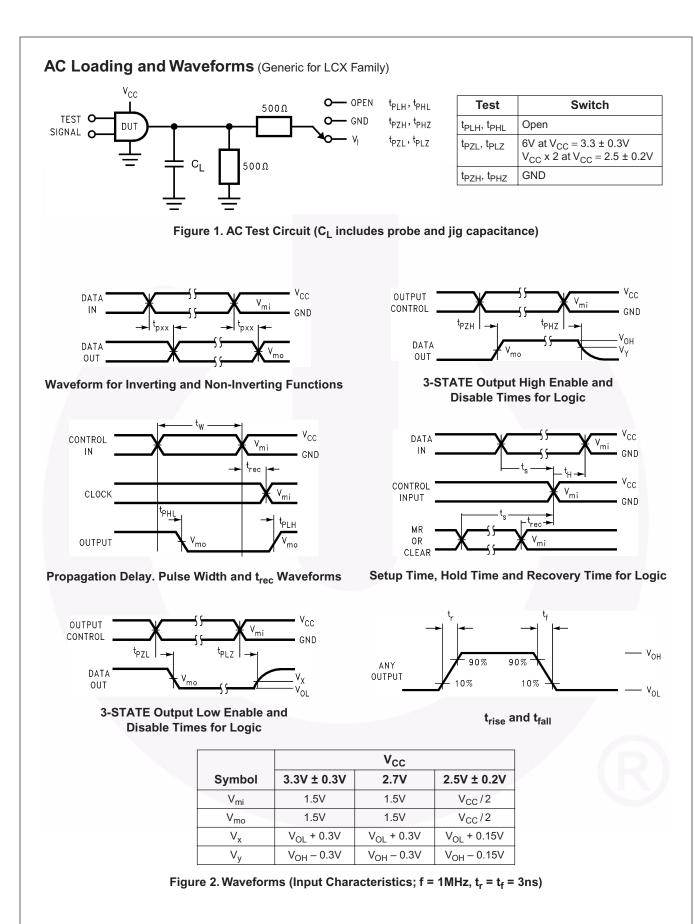
4. Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t<sub>OSHL</sub>) or LOW-to-HIGH (t<sub>OSLH</sub>).

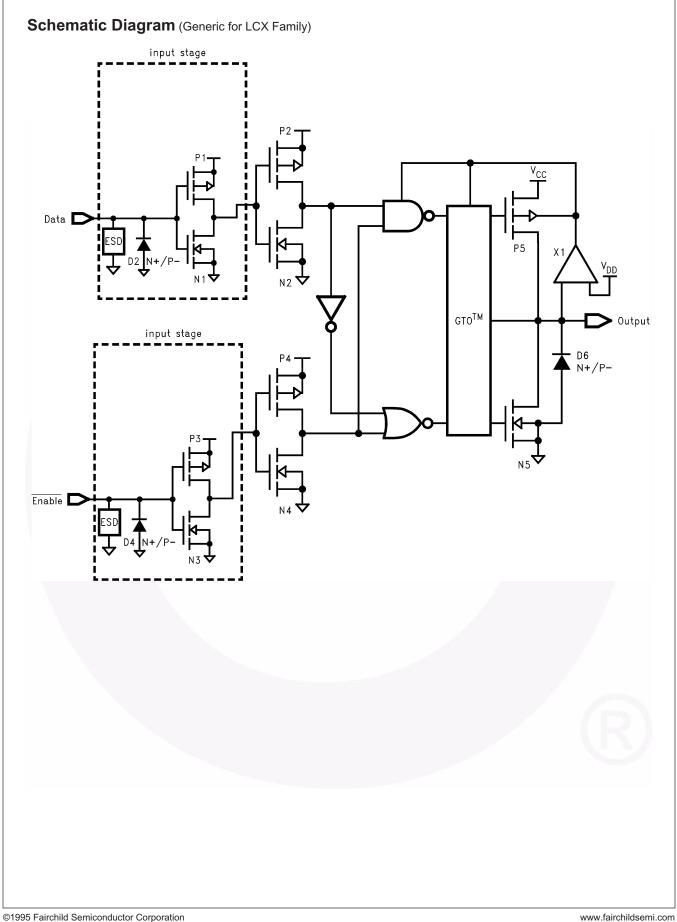
## **Dynamic Switching Characteristics**

|                  |   |                     |   | $T_A = 25^{\circ}C$ |      |
|------------------|---|---------------------|---|---------------------|------|
| Symbol           | Parameter                                   | V <sub>CC</sub> (V) | Conditions  | Typical             | Unit |
| V <sub>OLP</sub> | Quiet Output Dynamic Peak V <sub>OL</sub>   | 3.3                 | $C_L = 50 pF, V_{IH} = 3.3V, V_{IL} = 0V$         | 0.8                 | V    |
|                  |   | 2.5                 | $C_L = 30 pF$ , $V_{IH} = 2.5 V$ , $V_{IL} = 0 V$ | 0.6                 |      |
| V <sub>OLV</sub> | Quiet Output Dynamic Valley V <sub>OL</sub> | 3.3                 | $C_L = 50 pF, V_{IH} = 3.3V, V_{IL} = 0V$         | -0.8                | V    |
|                  |   | 2.5                 | $C_L = 30 pF, V_{IH} = 2.5V, V_{IL} = 0V$         | -0.6                |      |

## Capacitance

| Symbol           | Parameter                     | Conditions   | Typical | Units |
|------------------|-------------------------------|--|---------|-------|
| C <sub>IN</sub>  | Input Capacitance             | $V_{CC} = Open, V_I = 0V \text{ or } V_{CC}$         | 7       | pF    |
| C <sub>OUT</sub> | Output Capacitance            | $V_{CC} = 3.3 V$ , $V_I = 0 V$ or $V_{CC}$           | 8       | pF    |
| C <sub>PD</sub>  | Power Dissipation Capacitance | $V_{CC} = 3.3V$ , $V_I = 0V$ or $V_{CC}$ , f = 10MHz | 25      | pF    |





7

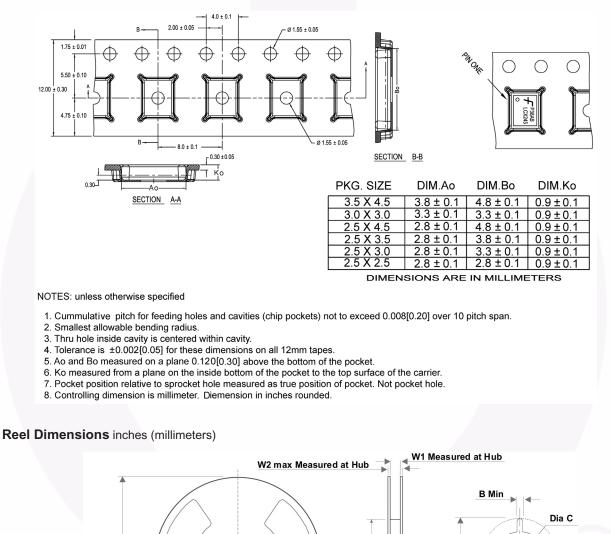
74LCX00 — Low Voltage Quad 2-Input NAND Gate with 5V Tolerant Inputs

## Tape and Reel Specification

#### **Tape Format for DQFN**

| Package Designator | Tape Section       | Number of Cavities | Cavity Status | Cover Tape Status |  |
|--------------------|--------------------|--------------------|---------------|-------------------|--|
| BQX                | Leader (Start End) | 125 (Тур.)         | Empty         | Sealed            |  |
|                    | Carrier            | 3000               | Filled        | Sealed            |  |
|                    | Trailer (Hub End)  | 75 (Тур.)          | Empty         | Sealed            |  |

#### Tape Dimensions inches (millimeters)



**Tape Size** 

12mm

Dia A

max

Α

13.0 (330.0)

В

0.059 (1.50)

W2

0.724 (18.4)

С

0.512 (13.00)

Dia N

See detail AA

D

0.795 (20.20)

Dia D

min

Ν

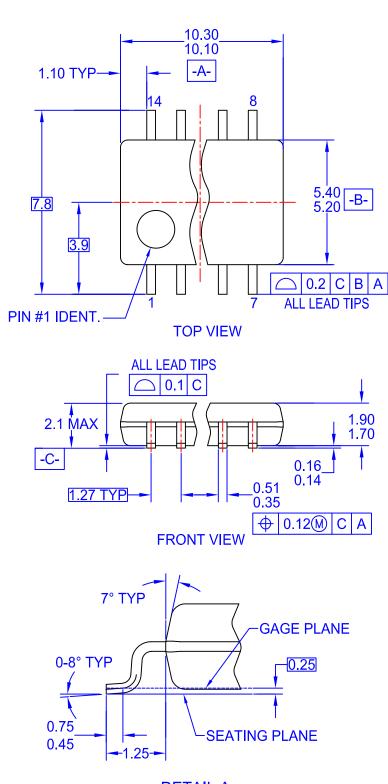
2.165 (55.00)

DETAIL AA

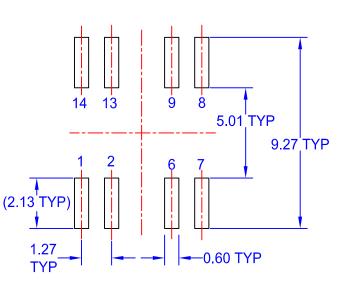
W1

0.488 (12.4)

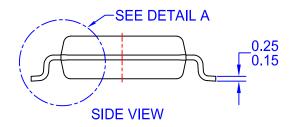








LAND PATTERN RECOMMENDATION

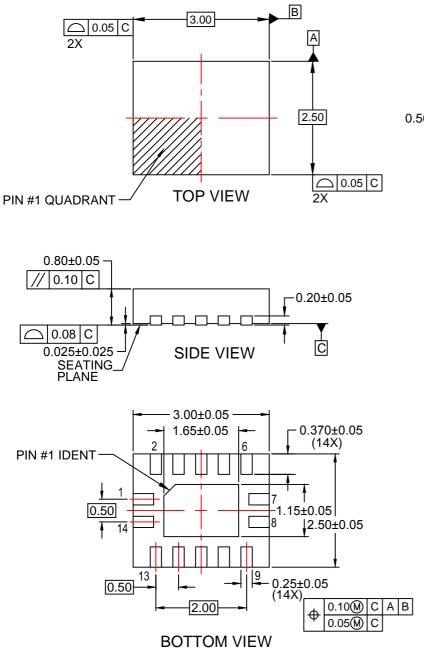


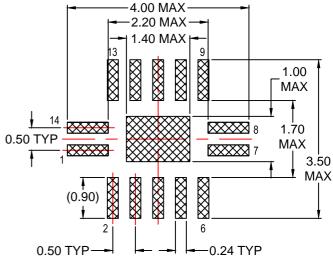
#### NOTES:

- A. CONFORMS TO EIAJ EDR-7320 REGISTRATION, ESTABLISHED IN DECEMBER, 1998.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- D. DRAWING FILENAME: MKT-M14Drev4.









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NOTES:

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- D. LAND PATTERN RECOMMENDATION IS EXISTING INDUSTRY LAND PATTERN.
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